

BIPOLAR DIGITAL INTEGRATED CIRCUIT $\mu PB1508GV$

3 GHz INPUT DIVIDE BY 2 PRESCALER IC FOR DBS TUNERS

 μ PB1508GV is a 3.0 GHz input divide by 2 prescaler IC for DBS tuner applications. μ PB1508GV can make VHF/UHF band PLL frequency synthesizer apply to DBS/ECS tuners. μ PB1508GV is a shrink package version of μ PB584G so that this small package contributes to reduce the mounting space.

 μ PB1508GV is manufactured using NEC's high ft NESATTM IV silicon bipolar process. This process uses silicon nitride passivation film and gold electrodes. These materials can protect chip surface from external pollution and prevent corrosion/migration. Thus, this IC has excellent performance, uniformity and reliability.

FEATURES

High toggle frequency : fin = 0.5 GHz to 3.0 GHz
High-density surface mounting : 8 pin plastic SSOP (175 mil)

• Low current consumption : 5 V, 12 mA

Fixed division : ÷2

APPLICATION

Prescaler between local oscillator and PLL frequency synthesizer included modulus prescaler

· DBS tuners with kit use of VHF/UHF band PLL frequency synthesizer

ORDERING INFORMATION

| PART NUMBER | PACKAGE | MARKING | SUPPLYING FORM |
|--------------|---------------------------------|---------|---|
| μPB1508GV-E1 | 8 pin plastic SSOP (175 mil) | 1508 | Embossed tape 8 mm wide. Pin 1 is in tape pull-out direction. 1 000 p/reel. |

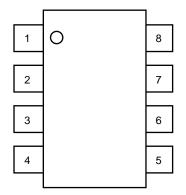
Remarks To order evaluation samples, please contact your local NEC sales office.

(Part number for sample order: μ PB1508GV)

Caution: Electro-static sensitive devices



PIN CONNECTION (Top View)



| Pin No. | Pin name |
|---------|----------|
| 1 | Vcc |
| 2 | IN |
| 3 | ĪN |
| 4 | GND |
| 5 | GND |
| 6 | NC |
| 7 | OUT |
| 8 | NC |

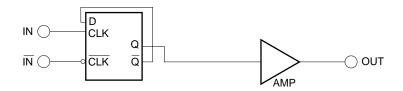
PRODUCT LINE-UP

| Product No. | Icc (mA) | fin (GHz) | Vcc (V) | Package | Pin Connection |
|-------------|----------|------------|------------|-----------------------|----------------|
| μPB581A | 30 | 0.5 to 2.8 | 4.5 to 5.5 | 8 pins CAN | - |
| μPB581C | 30 | 0.5 to 2.2 | 4.5 to 5.5 | 8 pins DIP (300 mil) | NEC Original |
| μPB584G | 18 | 0.5 to 2.5 | 4.5 to 5.5 | 8 pins SOP (225 mil) | NEC Original |
| μPB1508GV | 12 | 0.5 to 3.0 | 4.5 to 5.5 | 8 pins SSOP (175 mil) | |

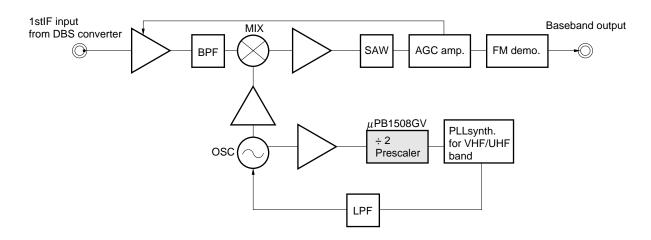
Remarks This table shows the TYP values of main parameters. Please refer to ELECTRICAL CHARACTERISTICS.

 μ PB581A, μ PB581C and μ PB584G are discontinued.

INTERNAL BLOCK DIAGRAM



SYSTEM APPLICATION EXAMPLE RF unit block of DBS tuners





PIN EXPLANATION

| Pin No. | Symbol | Applied voltage | PIN voltage | Functions and explanation |
|---------|--------|-----------------|-------------|---|
| 1 | Vcc | 4.5 to 5.5 | _ | Power supply pin. This pin must be equipped with bypass capacitor (eg 1 000 pF) to minimize ground impedance. |
| 2 | IN | _ | 1.7 to 4.95 | Signal input pin. This pin should be coupled to signal source with capacitor (eg 1 000 pF) for DC cut. |
| 3 | ĪN | _ | 1.7 to 4.95 | Signal input bypass pin. This pin must be equipped with bypass capacitor (eg 1 000 pF) to minimize ground impedance. |
| 4, 5 | GND | 0 | _ | Ground pin. Ground pattern on the board should be formed as wide as possible to minimize ground impedance. |
| 6, 8 | NC | _ | _ | Non connection pins. These pins should be opened. |
| 7 | OUT | | 1.0 to 4.7 | Divided frequency output pin. This pin is designed as emitter follower output. This pin can be connected to input of prescaler within PLL synthesizer through DC cut capacitor. |



ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | CONDITION | RATINGS | UNIT |
|-------------------------------|------------------|--|-------------|------|
| Supply voltage | Vcc | T _A = +25 °C | 6.0 | V |
| Input voltage | Vin | T _A = +25 °C | 6.0 | V |
| Total power dissipation | Po | Mounted on double sided copper clad $50 \times 50 \times 1.6$ mm epoxy glass PWB (T _A = +85 °C) | 250 | mW |
| Operating ambient temperature | TA | | -40 to +85 | °C |
| Storage temperature | T _{stg} | | -55 to +150 | °C |

RECOMMENDED OPERATING CONDITIONS

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT | REMARKS |
|-------------------------------|--------|------|------|------|------|---------|
| Supply voltage | Vcc | 4.5 | 5.0 | 5.5 | V | |
| Operating ambient temperature | TA | -40 | +25 | +85 | °C | |

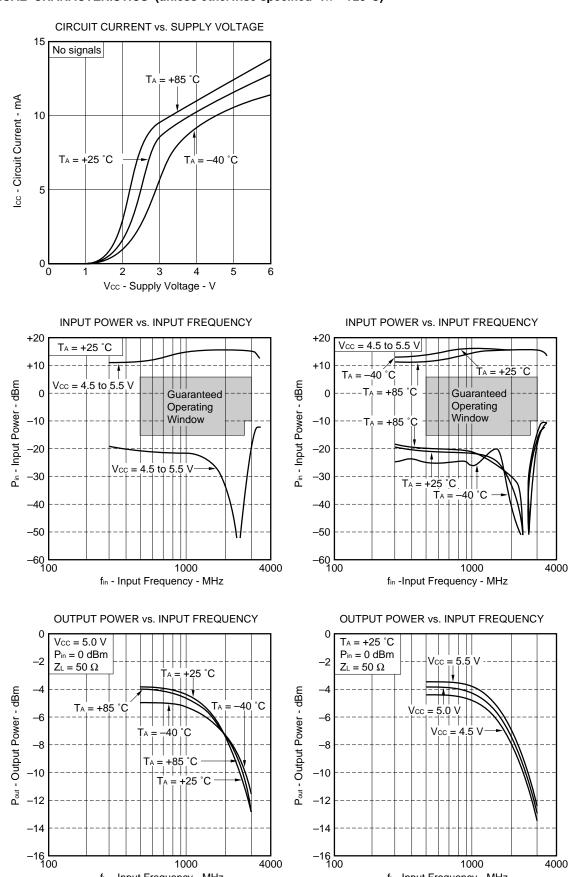
ELECTRICAL CHARACTERISTICS (TA = -40 to +85 °C, Vcc = 4.5 to 5.5 V, Zs = ZL = 50 Ω)

| PARAMETER | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNIT |
|-----------------------------------|--------------------|---|------|------|------|------|
| Circuit current | Icc | No signals | 7.6 | 12 | 14.5 | mA |
| Upper limit operating frequency 1 | fin(U)1 | $P_{in} = -10 \text{ to } +6 \text{ dBm}$ | 3.0 | _ | | GHz |
| Upper limit operating frequency 2 | fin(U)2 | $P_{in} = -15 \text{ to } +6 \text{ dBm}$ | 2.7 | _ | | GHz |
| Lower limit operating frequency | f _{in(L)} | $P_{in} = -15 \text{ to } +6 \text{ dBm}$ | _ | _ | 0.5 | GHz |
| Input power 1 | P _{in1} | fin = 2.7 to 3.0 GHz | -10 | _ | +6 | dBm |
| Input power 2 | P _{in2} | fin = 0.5 to 2.7 GHz | -15 | _ | +6 | dBm |
| Output power | Pout | Pin = 0 dBm, fin = 2 GHz | -12 | -7 | _ | dBm |



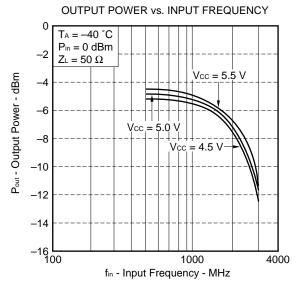
TYPICAL CHARACTERISTICS (unless otherwise specified TA = +25°C)

fin - Input Frequency - MHz



fin -Input Frequency - MHz

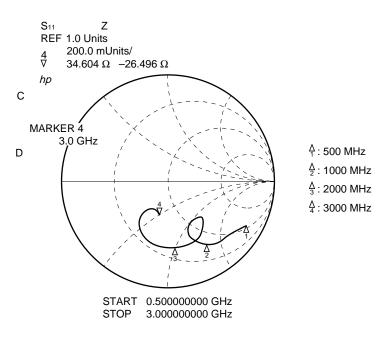




OUTPUT POWER vs. INPUT FREQUENCY T_A = +85 °C $P_{in} = 0 dBm$ $Z_L = 50 \Omega$ Vcc = 5.5 V Pout - Output Power - dBm -6 -8 Vcc = 4.5 V -10 -12 -14 -16 **└** 100 1000 4000 fin - Input Frequency - MHz

S₁₁ vs. INPUT FREQUENCY

Vcc = 5.0 V

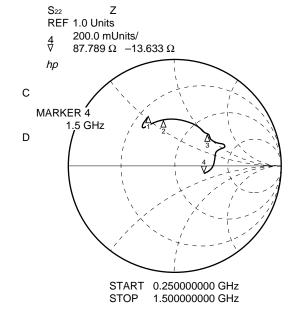


| FREQUENCY | 5 | S ₁₁ |
|-----------|------|-----------------|
| MHz | MAG | ANG |
| | | |
| 500.0000 | .850 | -30.2 |
| 600.0000 | .796 | -37.8 |
| 700.0000 | .790 | -39.2 |
| 800.0000 | .754 | -45.2 |
| 900.0000 | .766 | -53.7 |
| 1000.0000 | .701 | -57.6 |
| 1100.0000 | .660 | -62.3 |
| 1200.0000 | .606 | -67.2 |
| 1300.0000 | .571 | -70.3 |
| 1400.0000 | .521 | -70.6 |
| 1500.0000 | .495 | -68.3 |
| 1600.0000 | .441 | -60.6 |
| 1700.0000 | .479 | -45.1 |
| 1800.0000 | .602 | -62.3 |
| 1900.0000 | .595 | -74.2 |
| 2000.0000 | .608 | -82.9 |
| 2100.0000 | .603 | -89.8 |
| 2200.0000 | .599 | -97.3 |
| 2300.0000 | .588 | -107.7 |
| 2400.0000 | .532 | -122.0 |
| 2500.0000 | .396 | -132.0 |
| 2600.0000 | .325 | -127.1 |
| 2700.0000 | .270 | -123.6 |
| 2800.0000 | .232 | -122.7 |
| 2900.0000 | .258 | -105.8 |
| 3000.0000 | .351 | -103.7 |



S₂₂ vs. OUTPUT FREQUENCY

Vcc = 5.0 V, fin = 498 MHz



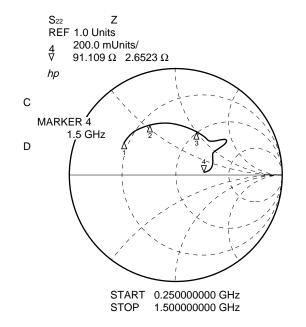
| FREQUENCY | s | 22 |
|-----------|------|-------|
| MHz | MAG | ANG |
| 250.0000 | .526 | 118.9 |
| 300.0000 | .463 | 131.2 |
| 350.0000 | .466 | 124.7 |
| 400.0000 | .460 | 117.1 |
| 450.0000 | .441 | 110.2 |
| 500.0000 | .456 | 103.0 |
| 550.0000 | .353 | 94.8 |
| 600.0000 | .438 | 91.1 |
| 650.0000 | .444 | 83.9 |
| 700.0000 | .436 | 78.3 |
| 750.0000 | .435 | 71.8 |
| 800.0000 | .431 | 65.9 |
| 850.0000 | .431 | 60.3 |
| 900.0000 | .431 | 53.7 |
| 950.0000 | .408 | 49.2 |
| 1000.0000 | .445 | 44.9 |
| 1050.0000 | .428 | 41.0 |
| 1100.0000 | .429 | 33.7 |
| 1150.0000 | .355 | 42.7 |
| 1200.0000 | .418 | 20.0 |
| 1250.0000 | .403 | 17.1 |
| 1300.0000 | .392 | 9.6 |
| 1350.0000 | .368 | 3.3 |
| 1400.0000 | .343 | -3.4 |
| 1450.0000 | .319 | -9.2 |
| 1500.0000 | .289 | -14.1 |

∆₁: 250 MHz

 $\frac{\Delta}{2}$: 500 MHz $\frac{\Delta}{3}$: 1000 MHz $\frac{\Delta}{4}$: 1500 MHz

S₂₂ vs. OUTPUT FREQUENCY

Vcc = 5.0 V, fin = 3002 MHz



| | 250.0000 | .555 | 146.6 |
|-------------------------------------|-----------|------|-------|
| | 300.0000 | .545 | 139.9 |
| | 350.0000 | .571 | 136.1 |
| | 400.0000 | .529 | 127.9 |
| | 450.0000 | .521 | 122.4 |
| | 500.0000 | .515 | 116.9 |
| | 550.0000 | .510 | 104.5 |
| ∆ : 250 MHz | 600.0000 | .492 | 106.6 |
| | 650.0000 | .487 | 100.9 |
| [∆] ₂ : 500 MHz | 700.0000 | .482 | 95.3 |
| $\frac{\Delta}{3}$: 1000 MHz | 750.0000 | .473 | 89.9 |
| ∆ 4 : 1500 MHz | 800.0000 | .461 | 83.8 |
| 4. 1300 MITZ | 850.0000 | .454 | 78.4 |
| | 900.0000 | .449 | 72.3 |
| | 950.0000 | .430 | 69.6 |
| | 1000.0000 | .443 | 64.3 |
| | 1050.0000 | .444 | 58.8 |
| | 1100.0000 | .440 | 52.3 |
| | 1150.0000 | .438 | 46.0 |
| | 1200.0000 | .501 | 37.5 |
| | 1250.0000 | .408 | 32.9 |
| | 1300.0000 | .388 | 25.1 |
| | 1350.0000 | .359 | 16.3 |
| | 1400.0000 | .335 | 9.7 |
| | | | |

1450.0000

1500.0000

.304

.285

FREQUENCY

MHz

S22

ANG

MAG

3.1

4.6



TEST CIRCUIT

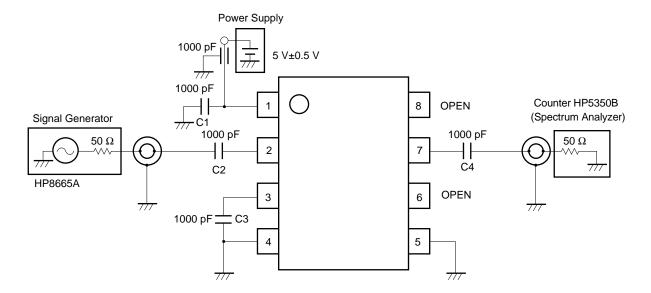
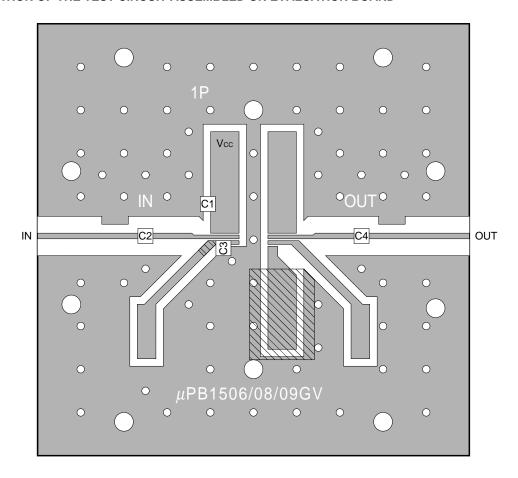




ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD



COMPONENT LIST

| SYMBOL | VALUE |
|----------|---------|
| C1 to C4 | 1000 pF |

EVALUATION BOARD CHARACTERS

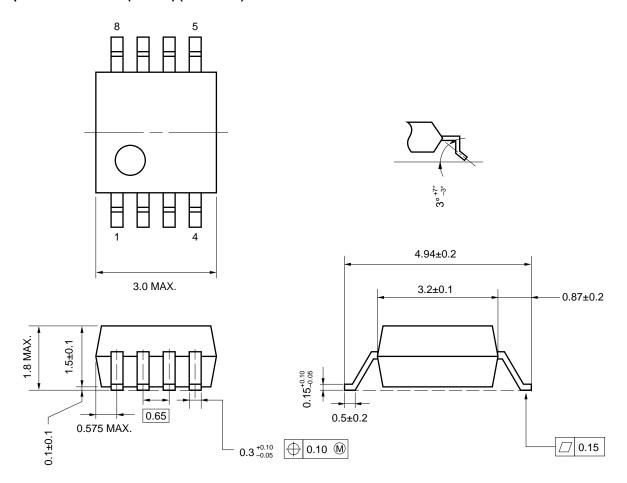
- (1) 35 μm thick double-sided copper clad 50 \times 50 \times 0.4 mm polyimide board
- (2) Back side: GND pattern
- (3) Solder plated patterns
- (4) ∘ ○: Through holes
- (5) of pin 3: partern should be removed.
- (6) of pin 5: short chip must be attached to be grounded.

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.



PACKAGE DIMENSIONS

8 pin PLASTIC SSOP (175 mil) (unit: mm)





NOTE CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as wide as possible to minimize ground impedance (to prevent undesired operation).
- (3) Keep the wiring length of the ground pins as short as possible.
- (4) Connect a bypass capacitor (e.g. 1 000 pF) to the Vcc pin.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered in the following recommended conditions. Other soldering methods and conditions than the recommended conditions are to be consulted with our sales representatives.

μPB1508GV

| Soldering method | Soldering conditions | Recommended condition symbol |
|---------------------|--|------------------------------|
| Infrared ray reflow | Package peak temperature: 235 °C, Hour: within 30 s. (more than 210 °C), Time: 3 times, Limited days: no.* | IR35-00-3 |
| VPS | Package peak temperature: 215 °C, Hour: within 40 s. (more than 200 °C), Time: 3 times, Limited days: no.* | VP15-00-3 |
| Wave soldering | Soldering tub temperature: less than 260 °C, Hour: within 10 s., Time: 1 time, Limited days: no. | WS60-00-1 |
| Pin part heating | Pin area temperature: less than 300 °C, Hour: within 3 s./pin, Limited days: no.* | |

^{*} It is the storage days after opening a dry pack, the storage conditions are 25 °C, less than 65 % RH.

Caution The combined use of soldering method is to be avoided (However, except the pin area heating method).

For details of recommended soldering conditions for surface mounting, refer to information document SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL (C10535E).



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Anti-radioactive design is not implemented in this product.

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